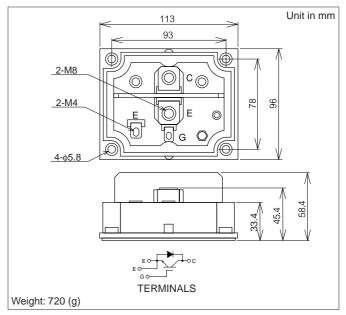
MBN600C20

Silicon N-channel IGBT

FEATURES

- * High thermal fatigue durability.
 (delta Tc=70°C,N>20,000cycles)
- * low noise due to built-in free-wheeling diode ultra soft fast recovery diode(USFD).
- *High speed,low loss IGBT module.
- *Low driving power due to low input capacitance MOS gate.
- *High reliability,high durability module.
- * Isolated head sink (terminal to base).

OUTLINE DRAWING



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

Item		Symbol	Unit	MBN600C20		
Collector Emitter Voltage		V _{CES}	V	2,000		
Gate Emitter Voltage		V_{GES}	V	±20		
Collector Current	DC	Ic	Α	600		
	1ms	I _{Cp}	A	1,200		
Forward Current	DC	l _F	^	600		
	1ms	Iғм	Α	1,200		
Collector Power Dissipation		Pc	W	4,000		
Junction Temperature	Tj	°C	-40 ~ +125			
Storage Temperature	T _{stg}	°C	-40 ~ +125			
Isolation Voltage	V _{ISO}	V _{RMS}	4,000(AC 1 minute)			
Screw Torque T	erminals(M4/M8)	-	N.m	2/10 (1)		
N	Nounting(M5)	-		2.8 (2)		

Notes: (1)Recommended Value 1.8±0.2/9±1N.m

(2)Recommended Value 2.6±0.2N.m

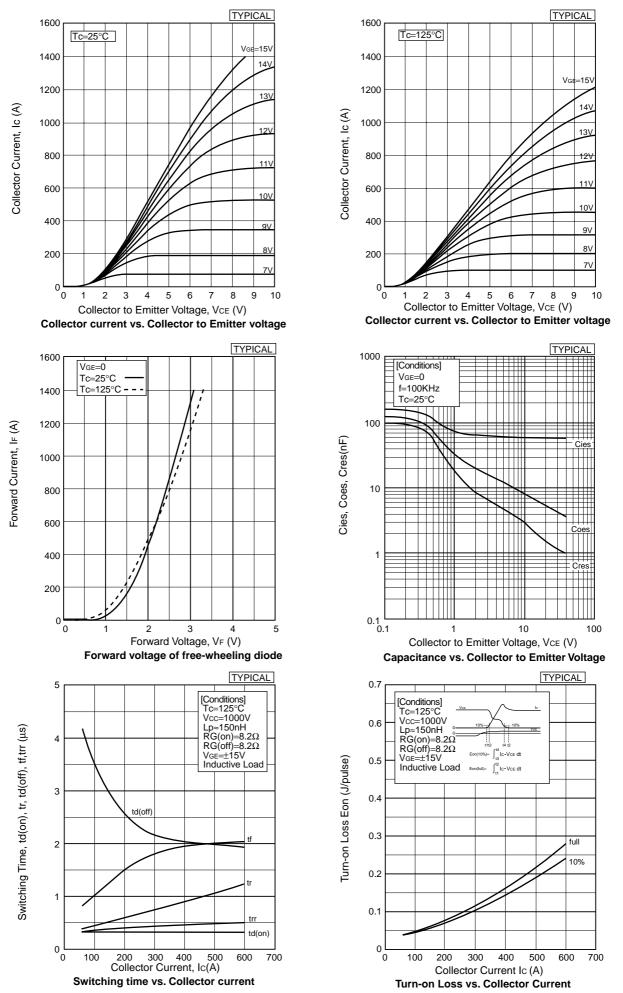
CHARACTERISTICS (Tc=25°C)

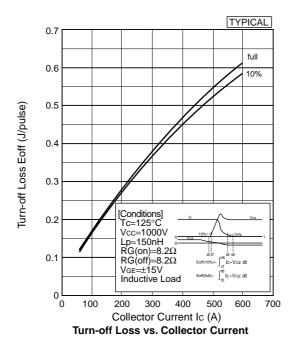
CHARACTERIOTICS (TC-25 C)								
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions	
Collector Emitter Cut-Off Current		I ces	mA	-	-	4.0	Vce=2,000V,Vge=0V	
Gate Emitter Leakage Current		I _{GES}	nA	-	-	±200	V _{GE} =±20V,V _{CE} =0V	
Collector Emitter Saturation Voltage		V _{CE(sat)}	V	-	4.4	5.4	I _C =600A,V _{GE} =15V	
Gate Emitter Threshold Voltage		V _{GE(TO)}	V	4.0	5.2	7.0	V _{CE} =10V, I _C =600mA	
Input Capacitance		Cies	nF	-	63	100	V _{CE} =10V,V _{GE} =0V,f=100KHz	
	Rise Time	t _r		-	1.3	2.1	V _{CC} =1,000V,Ic=600A	
Switching Times	Turn On Time	ton	μs	-	1.6	2.5	L=150nH	
Ü	Fall Time	t _f		-	2.0	2.7	$R_G=8.2\Omega$ (3)	
	Turn Off Time	t _{off}		-	4.0	5.9	V _{GE} =±15V Tc=125°C	
Peak Forward Voltage Drop		V_{FM}	V	-	2.2	3.2	-Ic=600A,V _{GE} =0V	
Reverse Recovery Time		t _{rr}	μS	-	0.5	0.9	Vcc=1,000V,-Ic=600A,L=150nH,	
							Tc=125°C (4)	
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.025	Junction to case	
	FWD	Rth(j-c)		-	-	0.05		

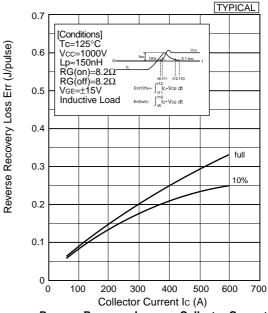
Notes:(3) R_G value is the test condition's value for decision of the switching times, not recommended value.

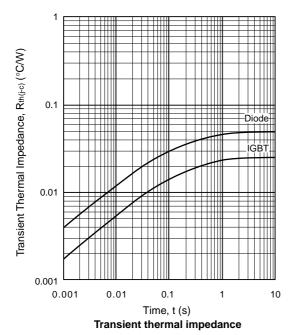
Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.

(4) Counter arm IGBT V_{GE}=-15V









Reverse Recovery Loss vs. Collector Current

HITACHI POWER SEMICONDUCTORS

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